

SEMICONDUCTOR®

SuperFET

FCH20N60 / FCA20N60 / FCA20N60_F109 600V N-Channel MOSFET

Features

- 650V @T_J = 150°C
- Typ. Rds(on)=0.15Ω
- Ultra low gate charge (typ. Qg=55nC)
- Low effective output capacitance (typ. Coss.eff=110pF)
- 100% avalanche tested
- RoHS Compliant



Description

SuperFETTM is, Fairchild's proprietary, new generation of high voltage MOSFET family that is utilizing an advanced charge balance mechanism for outstanding low on-resistance and lower gate charge performance.

This advanced technology has been tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy. Consequently, SuperFET is very suitable for various AC/DC power conversion in switching mode operation for system miniaturization and higher efficiency.



Absolute Maximum Ratings

Symbol		Parameter	FCH20N60	FCA20N60	Unit		
V _{DSS}	Drain-Source Voltage			600		V	
ID	Drain Current - Continuous ($T_C = 25^{\circ}C$) - Continuous ($T_C = 100^{\circ}C$)			20 12.5		A A	
I _{DM}	Drain Current - Pulsed		(Note 1)	60		А	
V _{GSS}	Gate-Source voltage			± 30		V	
E _{AS}	Single Pulsed Avalanche Energy			690		mJ	
I _{AR}	Avalanche Current		(Note 1)	20		А	
E _{AR}	Repetitive Avalanche Energy		(Note 1)	20.8		mJ	
dv/dt	Peak Diode Recovery dv/dt (Note		(Note 3)	4.5		V/ns	
P _D	Power Dissipation (T _C = 25°C) - Derate above 25°C			208 1.67		W W/°C	
T _{J,} T _{STG}	Operating and Storage Temperature Range			-55 to +150		°C	
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300		°C	

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		0.6	°C/W
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink	0.24		
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction-to-Ambient		41.7	°C/W

Package Marking and Ordering Information										
Device N	Device Marking Device Pac		kage	age Reel Size Tap		e Widt	h	Quantity		
FCH20N60 FCH20N60 7		TC)-247	-247 -		-		30		
FCA20N60 FCA20N60 T0		D-3PN	-		-		30			
FCA20	FCA20N60 FCA20N60_F109 T0		тс	D-3PN)-3PN -				30	
Electric	al Cha	racteristics T _c	= 25°C unles	ss otherwise not	ed					
Symbol	bol Parameter			Conditions			Min	Тур	Max	Units
Off Charac	teristics			1				Į	1	
BV _{DSS}	Drain-So	urce Breakdown Volta	ge	$V_{GS} = 0V,$	I _D = 250μA, T _J = 25°0	2	600			V
				$V_{GS} = 0V, I_D = 250\mu A, T_J = 150^{\circ}C$				650		V
ΔΒV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient			$I_D = 250\mu$ A, Referenced to 25°C				0.6		V/∘C
BV_{DS}	Drain-So Voltage	urce Avalanche Break	down	$V_{GS} = 0V,$	I _D = 20A			700		V
I _{DSS}	Zero Gate Voltage Drain Current			$V_{DS} = 600V, V_{GS} = 0V$ $V_{DS} = 480V, T_{C} = 125^{\circ}C$					1 10	μΑ μΑ
I _{GSSF}	Gate-Boo	ly Leakage Current, F	orward	$V_{GS} = 30V, V_{DS} = 0V$					100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse			V _{GS} = -30V, V _{DS} = 0V					-100	nA
On Charac	teristics			•						
V _{GS(th)}	Gate Threshold Voltage			$V_{DS} = V_{GS}, I_{D} = 250 \mu A$			3.0		5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance		V _{GS} = 10V, I _D = 10A				0.15	0.19	Ω	
9 _{FS}	Forward Transconductance			$V_{DS} = 40V, I_D = 10A$ (Note 4)				17		S
Dynamic C	haracteris	stics								•
C _{iss}	Input Capacitance			$V_{DS} = 25V, V_{GS} = 0V,$				2370	3080	pF
C _{oss}	Output Capacitance		f = 1.0MHz			1280	1665	pF		
C _{rss}	Reverse Transfer Capacitance						95		pF	
C _{oss}	Output Capacitance		$V_{DS} = 480V, V_{GS} = 0V, f = 1.0MHz$				65	85	pF	
C _{oss} eff.	Effective Output Capacitance		$V_{DS} = 0V$ to 400V, $V_{GS} = 0V$				165		pF	
Switching	Character	istics								•
t _{d(on)}	Turn-On Delay Time			$V_{DD} = 300V, I_D = 20A$				62	135	ns
t _r	Turn-On	Rise Time		$R_{G} = 25\Omega$				140	290	ns
t _{d(off)}	Turn-Off	Delay Time						230	470	ns
t _f	Turn-Off	Fall Time		(Not		(Note 4, 5)		65	140	ns
Qg	Total Gat	Gate Charge		$V_{DS} = 480^{\circ}$	V, I _D = 20A			75	98	nC
Q _{gs}	Gate-Sou	urce Charge		$V_{GS} = 10V$			13.5	18	nC	
Q _{gd}	Gate-Dra	Gate-Drain Charge			(Note 4, 5)			36		nC
Drain-Sour	ce Diode	Characteristics and	Maximum	Ratings			1	I	1	
I _S	Maximum Continuous Drain-Source Dioc			le Forward (Current				20	Α
I _{SM}	Maximum Pulsed Drain-Source Diode Fc			prward Current					60	A
V _{SD}	Drain-So	urce Diode Forward V	oltage	V _{GS} = 0V, I _S = 20A					1.4	V
t _{rr}	Reverse	Recovery Time		$V_{GS} = 0V,$	I _S = 20A			530		ns
0	Reverse	Recovery Charge		dI _F /dt =100A/μs (Note 4)				10.5		μC

NOTES:

1. Repetitive Rating: Pulse width limited by maximum junction temperature

2. I_{AS} = 10A, V_{DD} = 50V, R_{G} = 25 Ω , Starting T_{J} = 25 $^{\circ}C$

3. I_{SD} \leq 20A, di/dt \leq 200A/µs, V_{DD} \leq BV_{DSS}, Starting T_J = 25°C

4. Pulse Test: Pulse width $\leq 300 \mu s,$ Duty Cycle $\leq 2\%$

5. Essentially Independent of Operating Temperature Typical Characteristics



Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage



Figure 5. Capacitance Characteristics



Figure 2. Transfer Characteristics



Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperatue









Typical Performance Characteristics (Continued)



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